Quad R/S latch with 3-state outputs Rev. 10 — 18 November 2011

Product data sheet

1. **General description**

The HEF4043B is a quad R/S latch with 3-state outputs with a common output enable input (OE). Each latch has an active HIGH set input (1S to 4S), an active HIGH reset input (1R to 4R) and an active HIGH 3-state output (1Q to 4Q).

When OE is HIGH, the latch output (nQ) is determined by the nR and nS inputs as shown in Table 3. When OE is LOW, the latch outputs are in the high impedance OFF-state. OE does not affect the state of the latch. The high impedance off-state feature allows common bussing of the outputs.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD} , V_{SS} , or another input.

2. **Features and benefits**

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40 °C to +85 °C
- Complies with JEDEC standard JESD 13-B

3. Applications

Four-bit storage with output enable

Ordering information 4.

Table 1. **Ordering information**

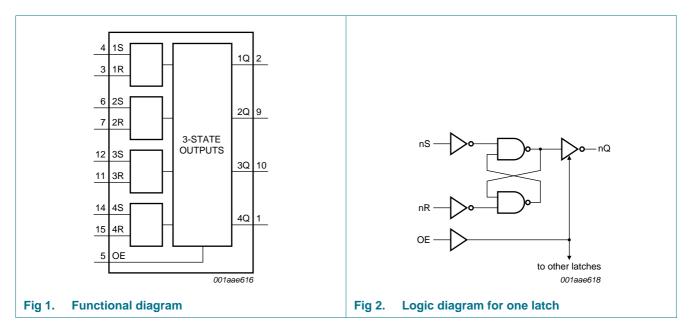
All types operate from -40 °C to +85 °C.

Type number	Package	Package						
	Name	Description	Version					
HEF4043BP	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4					
HEF4043BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1					



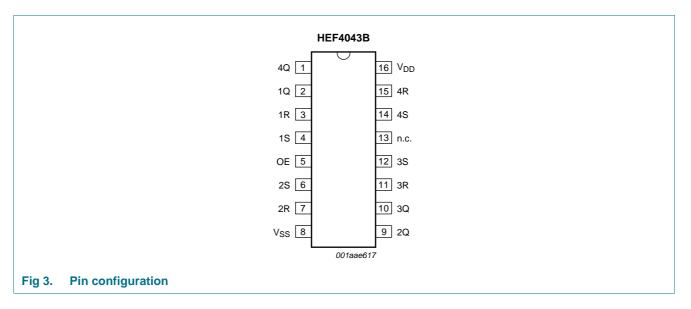
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5. Functional diagram



6. Pinning information

6.1 Pinning



Quad R/S latch with 3-state outputs

6.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
1Q to 4Q	2, 9, 10, 1	3-state buffered latch output
1R to 4R	3, 7, 11, 15	reset input (active HIGH)
1S to 4S	4, 6, 12, 14	set input (active HIGH)
OE	5	common output enable input
V _{SS}	8	ground supply voltage
n.c.	13	not connected
V _{DD}	16	supply voltage

7. Functional description

Table 3. Function table^[1]

Inputs OE	Output		
OE	nS	nR	nQ
L	Х	Х	Z
Н	L	Н	L
Н	Н	Х	Н
Н	L	L	latched

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high impedance state.

8. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DD}	supply voltage		-0.5	+18	V
l _{IK}	input clamping current	V_{I} < -0.5 V or V_{I} > V_{DD} + 0.5 V	-	±10	mA
VI	input voltage		-0.5	V _{DD} + 0.5	V
I _{OK}	output clamping current	V_{O} < –0.5 V or V_{O} > V_{DD} + 0.5 V	-	±10	mA
I _{I/O}	input/output current		-	±10	mA
I _{DD}	supply current		-	50	mA
T _{stg}	storage temperature		-65	+150	°C
T _{amb}	ambient temperature		-40	+85	°C
P _{tot}	total power dissipation	T _{amb} –40 °C to +85 °C			
		DIP16 package	<u>[1]</u> _	750	mW
		SO16 package	[2] _	500	mW
Р	power dissipation	per output	-	100	mW

[1] For DIP16 package: P_{tot} derates linearly with 12 mW/K above 70 °C.

[2] For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 °C.

9. Recommended operating conditions

Recommended operating condition	Recommended operating conditions							
Parameter	Conditions	Min	Тур	Max	Unit			
supply voltage		3	-	15	V			
input voltage		0	-	V_{DD}	V			
ambient temperature	in free air	-40	-	+85	°C			
input transition rise and fall rate	$V_{DD} = 5 V$	-	-	3.75	μs/V			
	V _{DD} = 10 V	-	-	0.5	μs/V			
	V _{DD} = 15 V	-	-	0.08	μs/V			
	Parameter supply voltage input voltage ambient temperature	supply voltageinput voltageambient temperaturein free airinput transition rise and fall rate $V_{DD} = 5 V$ $V_{DD} = 10 V$	ParameterConditionsMinsupply voltage3input voltage0ambient temperaturein free air-40input transition rise and fall rate $V_{DD} = 5 V$ - $V_{DD} = 10 V$ -	ParameterConditionsMinTypsupply voltage3-input voltage0-ambient temperaturein free air-40-input transition rise and fall rate $V_{DD} = 5 V$ $V_{DD} = 10 V$	ParameterConditionsMinTypMaxsupply voltage3-15input voltage0- V_{DD} ambient temperaturein free air-40-+85input transition rise and fall rate $V_{DD} = 5 V$ 3.75 $V_{DD} = 10 V$ 0.5			

10. Static characteristics

Table 6. Static characteristics

 $V_{SS} = 0$ V; $V_I = V_{SS}$ or V_{DD} unless otherwise specified.

Symbol	Parameter	Conditions	V_{DD}	T _{amb} =	–40 °C	T _{amb} =	25 °C	T _{amb} =	85 °C	Unit
				Min	Max	Min	Max	Min	Max	
V _{IH}	HIGH-level input voltage	I _O < 1 μΑ	5 V	3.5	-	3.5	-	3.5	-	V
			10 V	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	V
V _{IL}	LOW-level input voltage	I _O < 1 μA	5 V	-	1.5	-	1.5	-	1.5	V
			10 V	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	V
V _{OH}	HIGH-level output voltage	I _O < 1 μA	5 V	4.95	-	4.95	-	4.95	-	V
			10 V	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	V
V _{OL}	V _{OL} LOW-level output voltage	I _O < 1 μA	5 V	-	0.05	-	0.05	-	0.05	V
		10 V	-	0.05	-	0.05	-	0.05	V	
			15 V	-	0.05	-	0.05	-	0.05	V
I _{OH}	HIGH-level output current	$V_{O} = 2.5 V$	5 V	-	-1.7	-	-1.4	-	-1.1	mA
		$V_{O} = 4.6 V$	5 V	-	-0.52	-	-0.44	-	-0.36	mA
		$V_{O} = 9.5 V$	10 V	-	-1.3	-	-1.1	-	-0.9	mA
		V _O = 13.5 V	15 V	-	-3.6	-	-3.0	-	-2.4	mA
I _{OL}	LOW-level output current	$V_{O} = 0.4 V$	5 V	0.52	-	0.44	-	0.36	-	mA
		$V_{O} = 0.5 V$	10 V	1.3	-	1.1	-	0.9	-	mA
		V _O = 1.5 V	15 V	3.6	-	3.0	-	2.4	-	mA
I _I	input leakage current		15 V	-	±0.3	-	±0.3	-	±1.0	μA
I _{OZ}	OFF-state output current	nQ output HIGH; returned to V _{DD}	15 V	-	1.6	-	1.6	-	12.0	μA
		nQ output LOW; returned to V _{SS}	15 V	-	1.6	-	1.6	-	12.0	μΑ

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Table 6. Static characteristics ...continued

 $V_{SS} = 0$ V; $V_I = V_{SS}$ or V_{DD} unless otherwise specified.

Symbol	Parameter	Conditions	V _{DD}	T _{amb} =	–40 °C	T _{amb} =	25 °C	T _{amb} =	= 85 °C	Unit
				Min	Max	Min	Max	Min	Max	
I _{DD}	supply current	I _O = 0 A	5 V	-	20	-	20	-	150	μA
			10 V	-	40	-	40	-	300	μΑ
			15 V	-	80	-	80	-	600	μΑ
CI	input capacitance			-	-	-	7.5	-	-	pF

11. Dynamic characteristics

Table 7. Dynamic characteristics

 $V_{SS} = 0$ V; $T_{amb} = 25$ °C; For waveforms and test circuit see <u>Section 12</u>; unless otherwise specified.

Symbol	Parameter	Conditions	V_{DD}	Extrapolation formula	Min	Тур	Max	Unit
t _{PHL}	HIGH to LOW	$nR \rightarrow nQ;$	5 V	[1] 63 ns + (0.55 ns/pF)C _L	-	90	180	ns
	propagation delay	see Figure 4	10 V	24 ns + (0.23 ns/pF)C _L	-	35	70	ns
			15 V	17 ns + (0.16 ns/pF)C _L	-	25	50	ns
t _{PLH}	LOW to HIGH	$nS \rightarrow nQ;$	5 V	[1] 38 ns + (0.55 ns/pF)C _L	-	65	135	ns
	propagation delay	see Figure 4	10 V	14 ns + (0.23 ns/pF)C _L	-	25	50	ns
			15 V	7 ns + (0.16 ns/pF)C _L	-	15	35	ns
t _t	transition time	nQ output;	5 V	[1] [2] 10 ns + (1.00 ns/pF)CL	-	60	120	ns
		see Figure 4	10 V	9 ns + (0.42 ns/pF)C _L	-	30	60	ns
		15 V	6 ns + (0.28 ns/pF)C _L	-	20	40	ns	
t _{PHZ}	HIGH to OFF-state	$OE \rightarrow nQ;$	5 V		-	45	90	ns
	propagation delay	see Figure 5	10 V		-	20	35	ns
			15 V		-	10	25	ns
t _{PLZ}	LOW to OFF-state	OE → nQ; see <u>Figure 5</u>	5 V		-	50	100	ns
	propagation delay		10 V		-	20	40	ns
			15 V		-	10	25	ns
t _{PZH}	OFF-state to HIGH	$OE \rightarrow nQ;$	5 V		-	25	50	ns
	propagation delay	see <u>Figure 5</u>	10 V		-	15	30	ns
			15 V		-	10	25	ns
t _{PZL}	OFF-state to LOW	$OE \rightarrow nQ;$	5 V		-	40	80	ns
	propagation delay	see <u>Figure 5</u>	10 V		-	20	45	ns
			15 V		-	15	35	ns
t _W	pulse width	nS input HIGH;	5 V		30	15	-	ns
		minimum width; see Figure 4	10 V		20	10	-	ns
		See <u>Figure 4</u>	15 V		16	8	-	ns
		nR input HIGH;	5 V		30	15	-	ns
		minimum width;	10 V		20	10	-	ns
		see <u>Figure 4</u>	15 V		16	8	-	ns

[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C_L in pF).

[2] t_t is the same as t_{THL} and t_{TLH} .

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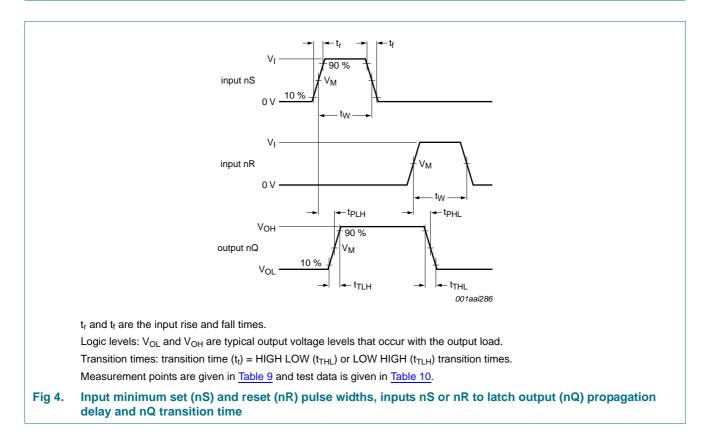
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Symbol	Parameter	V_{DD}	Typical formula for P_D (μ W)	where:
P _D	dynamic power	5 V	$P_D = 1100 \times f_i + \Sigma(f_o \times C_L) \times V_DD{}^2$	$f_i = input frequency in MHz;$
	dissipation	10 V	$P_D = 4400 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2$	f_o = output frequency in MHz;
		15 V	$P_{D} = 11400 \times f_{i} + \Sigma(f_{o} \times C_{L}) \times V_{DD}^2$	C_L = output load capacitance in pF;
				V _{DD} = supply voltage in V;
				$\Sigma(f_o \times C_L)$ = sum of the outputs.

Table 8. Dynamic power dissipation P_D

12. Waveforms



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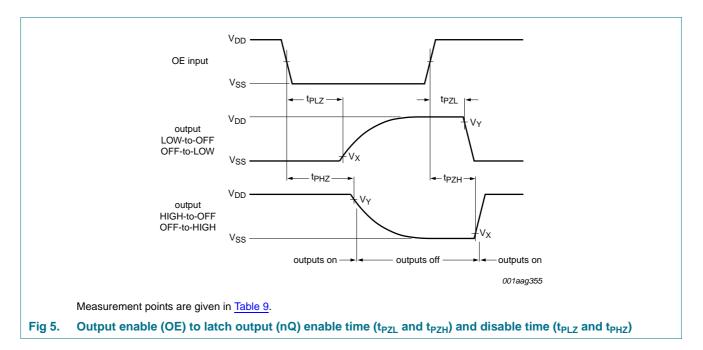


Table 9.Measurement points

Supply voltage	Input	Output			
V _{DD}	VI	V _M	V _M	V _X	V _Y
5 V to 15 V	V _{DD} or 0 V	0.5V _{DD}	0.5V _{DD}	0.1V _{DD}	0.9V _{DD}

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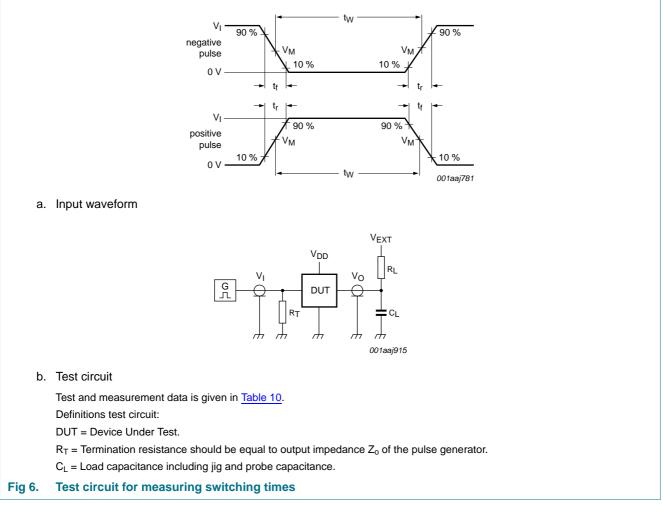


Table 10. Test data

Supply voltage	Input		Load	oad V _{EXT}			_	
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
5 V to 15 V	V _{DD}	\leq 20 ns	50 pF	1 kΩ	open	V _{DD}	GND	

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13. Package outline

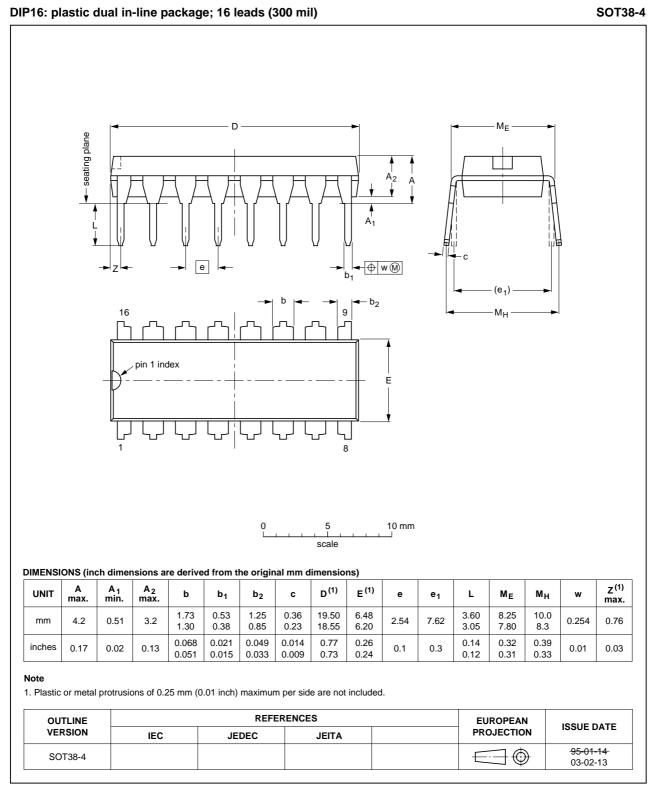


Fig 7. Package outline SOT38-4 (DIP16)

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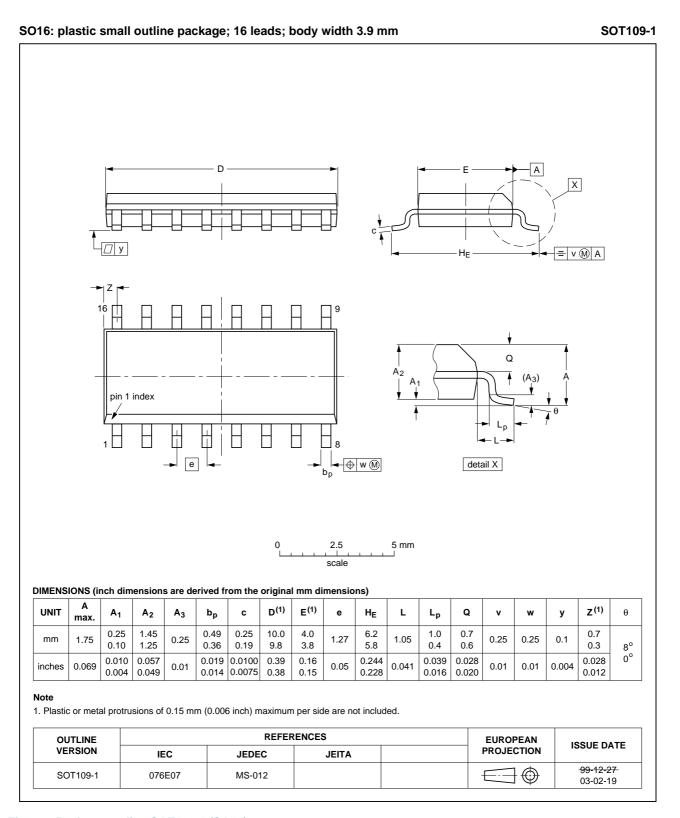


Fig 8. Package outline SOT109-1 (SO16)

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14. Revision history

Table 11. Revision hist	tory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4043B v.10	20111118	Product data sheet	-	HEF4043B v.9
Modifications:	 <u>Table 6</u>: I_{OH} 	minimum values changed to n	naximum	
HEF4043B v.9	20091216	Product data sheet	-	HEF4043B v.8
HEF4043B v.8	20091127	Product data sheet	-	HEF4043B v.7
HEF4043B v.7	20090710	Product data sheet	-	HEF4043B v.6
HEF4043B v.6	20081111	Product data sheet	-	HEF4043B v.5
HEF4043B v.5	20080729	Product data sheet	-	HEF4043B v.4
HEF4043B v.4	20080710	Product data sheet	-	HEF4043B_CNV v.3
HEF4043B_CNV v.3	19950101	Product specification	-	HEF4043B_CNV v.2
HEF4043B_CNV v.2	19950101	Product specification	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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